

# Digital FET, N-Channel FDV301N, FDV301N-F169

#### **General Description**

This N-Channel logic level enhancement mode field effect transistor is produced using **onsemi's** proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors. Since bias resistors are not required, this one N-channel FET can replace several different digital transistors, with different bias resistor values.

#### **Features**

- 25 V, 0.22 A Continuous, 0.5 A Peak
  - $R_{DS(on)} = 5 \Omega @ V_{GS} = 2.7 V$
  - $R_{DS(on)} = 4 \Omega @ V_{GS} = 4.5 V$
- Very Low Level Gate Drive Requirements Allowing Direct Operation in 3 V Circuits. V<sub>GS(th)</sub> < 1.06 V</li>
- Gate-Source Zener for ESD Ruggedness. > 6 kV Human Body Model
- Replace Multiple NPN Digital Transistors with One DMOS FET
- This Device is Pb-Free and Halide Free

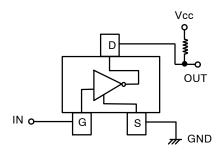
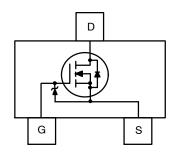


Figure 1. Inverter Application





SOT-23 CASE 318-08

#### **MARKING DIAGRAM**



&E = Designates Space &Y = Binary Calendar Year Coding Scheme

301 = Specific Device Code

&G = Date Code

#### **ORDERING INFORMATION**

| Device                   | Package                               | Shipping <sup>†</sup> |
|--------------------------|---------------------------------------|-----------------------|
| FDV301N,<br>FDV301N-F169 | SOT-23-3<br>(Pb-Free,<br>Halide-Free) | 3000 /<br>Tape & Reel |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### ABSOLUTE MAXIMUM RATINGS $T_A$ = $25^{\circ}C$ unless otherwise noted.

| Symbol                             | Parameter  | FDV301N    | Unit |
|------------------------------------|--|------------|------|
| V <sub>DSS</sub> , V <sub>CC</sub> | Drain-Source Voltage, Power Supply Voltage   | 25         | V    |
| V <sub>GSS</sub> , V <sub>I</sub>  | Gate-Source Voltage, V <sub>IN</sub>   | 8          | V    |
| I <sub>D</sub> , I <sub>O</sub>    | Drain/Output Current - Continuous  | 0.22       | Α    |
|                                    |  | 0.5        |      |
| P <sub>D</sub>                     | Maximum Power Dissipation  | 0.35       | W    |
| T <sub>J</sub> , T <sub>STG</sub>  | Operating and Storage Temperature Range  | -55 to 150 | °C   |
| ESD                                | Electrostatic Discharge Rating MIL–STD–883D Human Body Model (100 pF/1500 $\Omega$ ) | 6.0        | kV   |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS T<sub>A</sub> = 25°C unless otherwise noted.

| Symbol         | Parameter                               | Value | Unit |
|----------------|---|-------|------|
| $R_{	heta JA}$ | Thermal Resistance, Junction-to-Ambient | 357   | °C/W |

#### **INVERTER ELECTRICAL CHARACTERISTICS** $T_A = 25^{\circ}C$ unless otherwise noted.

| Symbol              | Parameter                         | Test Conditions                                | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|--|-----|-----|-----|------|
| I <sub>O(off)</sub> | Zero Input Voltage Output Current | V <sub>CC</sub> = 20 V, V <sub>I</sub> = 0 V   | _   | -   | 1   | μΑ   |
| V <sub>I(off)</sub> | Input Voltage                     | $V_{CC} = 5 \text{ V}, I_{O} = 10 \mu\text{A}$ | _   | -   | 0.5 | V    |
| V <sub>I(on)</sub>  |                                   | $V_O = 0.3 \text{ V}, I_O = 0.005 \text{ A}$   | 1   | -   | _   |      |
| R <sub>O(on)</sub>  | Output to Ground Resistance       | V <sub>I</sub> = 2.7 V, I <sub>O</sub> = 0.2 A | _   | 4   | 5   | Ω    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **ELECTRICAL CHARACTERISTICS** $T_A = 25^{\circ}C$ unless otherwise noted.

| Symbol                         | Parameter                                   | Test Conditions  | Min  | Тур  | Max  | Unit  |
|--------------------------------|---|--|------|------|------|-------|
| OFF CHARACT                    | TERISTICS                                   |  |      | •    |      |       |
| BV <sub>DSS</sub>              | Drain-Source Breakdown Voltage              | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$                            | 25   | -    | _    | V     |
| $\Delta BV_{DSS}/\Delta T_{J}$ | Breakdown Voltage Temp. Coefficient         | I <sub>D</sub> = 250 μA, Referenced to 25°C                              | -    | 25   | -    | mV/°C |
| I <sub>DSS</sub>               | Zero Gate Voltage Drain Current             | V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V                            | -    | -    | 1    | μΑ    |
|                                |   | V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55°C     | -    | -    | 10   |       |
| I <sub>GSS</sub>               | Gate - Body Leakage Current                 | V <sub>GS</sub> = 8 V, V <sub>DS</sub> = 0 V                             | -    | -    | 100  | nA    |
| ON CHARACTI                    | ERISTICS                                    |  |      |      |      |       |
| $\Delta V_{GS(th)}/\Delta T_J$ | Gate Threshold Voltage Temp.<br>Coefficient | I <sub>D</sub> = 250 μA, Referenced to 25°C                              | _    | -2.1 | -    | mV/°C |
| V <sub>GS(th)</sub>            | Gate Threshold Voltage                      | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$                                     | 0.70 | 0.85 | 1.06 | V     |
| R <sub>DS(on)</sub>            | Static Drain-Source On-Resistance           | V <sub>GS</sub> = 2.7 V, I <sub>D</sub> = 0.2 A                          | -    | 3.8  | 5    | Ω     |
|                                |   | $V_{GS} = 2.7 \text{ V}, I_D = 0.2 \text{ A}, T_J = 125^{\circ}\text{C}$ | -    | 6.3  | 9    |       |
|                                |   | V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 0.4 A                          | -    | 3.1  | 4    |       |
| I <sub>D(on)</sub>             | On-State Drain Current                      | V <sub>GS</sub> = 2.7 V, V <sub>DS</sub> = 5 V                           | 0.2  | -    | -    | Α     |
| 9FS                            | Forward Transconductance                    | V <sub>DS</sub> = 5 V, I <sub>D</sub> = 0.4 A                            | -    | 0.2  | -    | S     |

#### ELECTRICAL CHARACTERISTICS T<sub>A</sub> = 25°C unless otherwise noted. (continued)

| Symbol              | Parameter   | Test Conditions  | Min | Тур  | Max  | Unit |
|---------------------|---|--|-----|------|------|------|
| YNAMIC CH           | ARACTERISTICS   |  |     |      |      |      |
| C <sub>iss</sub>    | Input Capacitance                                     | V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1.0 MHz           | -   | 9.5  | _    | pF   |
| C <sub>oss</sub>    | Output Capacitance                                    |  | -   | 6    | _    |      |
| C <sub>rss</sub>    | Reverse Transfer Capacitance                          |  | -   | 1.3  | -    |      |
| WITCHING O          | CHARACTERISTICS (Note 1)                              |  |     |      |      |      |
| t <sub>D(on)</sub>  | Turn - On Delay Time                                  | $V_{DD} = 6 \text{ V}, I_D = 0.5 \text{ A}, V_{GS} = 4.5 \text{ V},$ | -   | 3.2  | 8    | ns   |
| t <sub>r</sub>      | Turn – On Rise Time                                   | $R_{GEN} = 50 \Omega$  | -   | 6    | 15   |      |
| t <sub>D(off)</sub> | Turn – Off Delay Time                                 |  | -   | 3.5  | 8    |      |
| t <sub>f</sub>      | Turn – Off Fall Time                                  |  | -   | 3.5  | 8    |      |
| $Q_g$               | Total Gate Charge                                     | $V_{DS} = 5 \text{ V}, I_D = 0.2 \text{ A}, V_{GS} = 4.5 \text{ V}$  | -   | 0.49 | 0.7  | nC   |
| Q <sub>gs</sub>     | Gate-Source Charge                                    | ]  | -   | 0.22 | _    |      |
| $Q_{gd}$            | Gate-Drain Charge                                     |  | -   | 0.07 |      |      |
| RAIN-SOUF           | RCE DIODE CHARACTERISTICS AND M                       | AXIMUM RATINGS   |     |      |      |      |
| IS                  | Maximum Continuous Drain-Source Diode Forward Current |  | -   | -    | 0.29 | Α    |
| V <sub>SD</sub>     | Drain-Source Diode Forward Voltage                    | V <sub>GS</sub> = 0 V, I <sub>S</sub> = 0.29 A (Note 1)              | -   | 0.8  | 1.2  | V    |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

#### TYPICAL CHARACTERISTICS

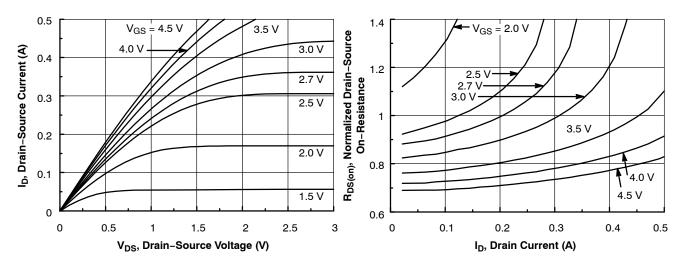
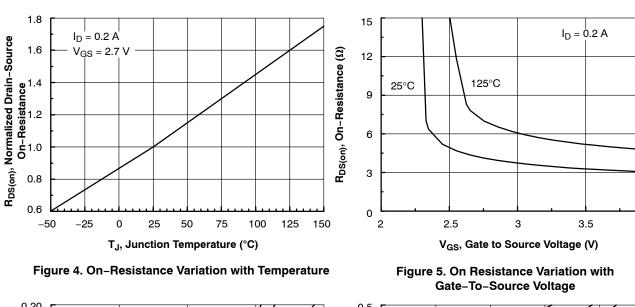


Figure 2. On-Region Characteristics

Figure 3. On-Resistance Variation with Drain Current and Gate Voltage

#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)



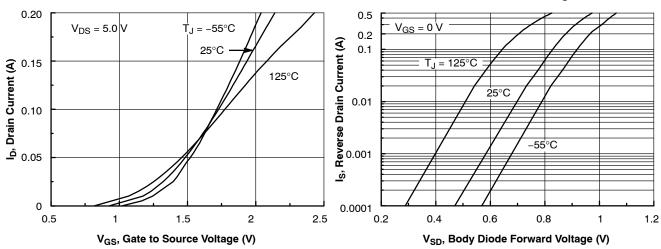


Figure 6. Transfer Characteristics

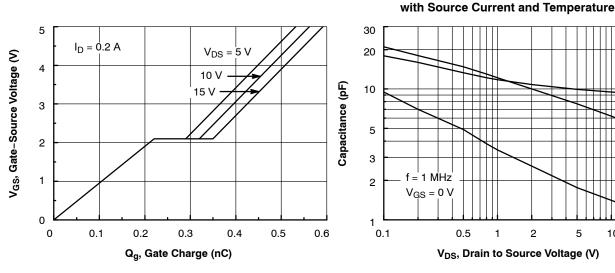


Figure 8. Gate Charge Characteristics

Figure 9. Capacitance Characteristics

Figure 7. Body Diode Forward Voltage Variation

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#### TYPICAL PERFORMANCE CHARACTERISTICS (continued)

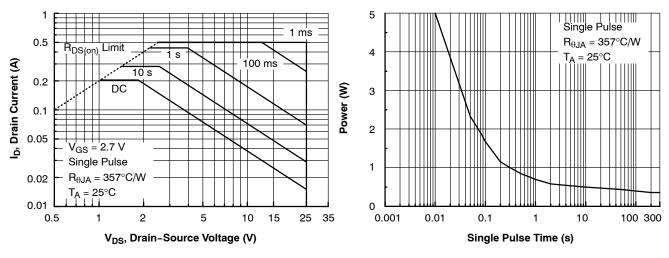


Figure 10. Maximum Safe Operating Area

Figure 11. Single Pulse Maximum Power Dissipation

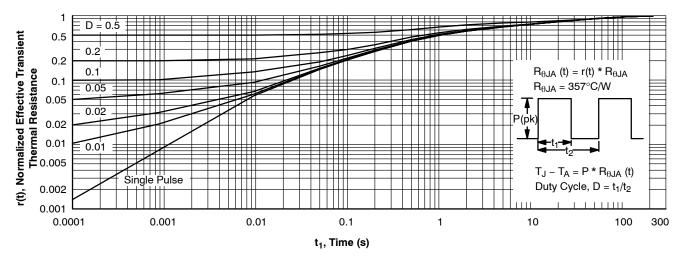


Figure 12. Transient Thermal Response Curve



SOT-23 (TO-236) CASE 318-08 **ISSUE AS** 

**DATE 30 JAN 2018** 

## SCALE 4:1 D - 3X b

**TOP VIEW** 







#### **RECOMMENDED SOLDERING FOOTPRINT**



DIMENSIONS: MILLIMETERS

#### NOTES:

- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.
  3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH.
  MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL
- 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH,

| PROT | RUSIONS, OR GATE BURRS. |   |
|------|-------------------------|---|
|      |                         | T |

|     | MILLIMETERS |      |      | INCHES |       |       |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| Α   | 0.89        | 1.00 | 1.11 | 0.035  | 0.039 | 0.044 |
| A1  | 0.01        | 0.06 | 0.10 | 0.000  | 0.002 | 0.004 |
| b   | 0.37        | 0.44 | 0.50 | 0.015  | 0.017 | 0.020 |
| С   | 0.08        | 0.14 | 0.20 | 0.003  | 0.006 | 0.008 |
| D   | 2.80        | 2.90 | 3.04 | 0.110  | 0.114 | 0.120 |
| E   | 1.20        | 1.30 | 1.40 | 0.047  | 0.051 | 0.055 |
| е   | 1.78        | 1.90 | 2.04 | 0.070  | 0.075 | 0.080 |
| L   | 0.30        | 0.43 | 0.55 | 0.012  | 0.017 | 0.022 |
| L1  | 0.35        | 0.54 | 0.69 | 0.014  | 0.021 | 0.027 |
| HE  | 2.10        | 2.40 | 2.64 | 0.083  | 0.094 | 0.104 |
| T   | 0°          |      | 10°  | 0°     |       | 10°   |

#### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code

= Date Code

= Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

| STYLE 1 THRU 5:<br>CANCELLED | STYLE 6:<br>PIN 1. BASE<br>2. EMITTER<br>3. COLLECTOR | STYLE 7:<br>PIN 1. EMITTER<br>2. BASE<br>3. COLLECTOR | STYLE 8:<br>PIN 1. ANODE<br>2. NO CONNECTION<br>3. CATHODE |
|------------------------------|---|---|--|
| OT (1 F O                    |   |   |  |

SOT-23 (TO-236)

| STYLE 9:                  | STYLE 10:                | STYLE 11:                       | STYLE 12:                 | STYLE 13:     | STYLE 14:               |
|---------------------------|--------------------------|---------------------------------|---------------------------|---------------|-------------------------|
| PIN 1. ANODE              | PIN 1. DRAIN             | PIN 1. ANODE                    | PIN 1. CATHODE            | PIN 1. SOURCE | PIN 1. CATHODE          |
| <ol><li>ANODE</li></ol>   | <ol><li>SOURCE</li></ol> | <ol><li>CATHODE</li></ol>       | <ol><li>CATHODE</li></ol> | 2. DRAIN      | 2. GATE                 |
| <ol><li>CATHODE</li></ol> | 3. GATE                  | <ol><li>CATHODE-ANODE</li></ol> | <ol><li>ANODE</li></ol>   | 3. GATE       | <ol><li>ANODE</li></ol> |

| STYLE 15:                 | STYLE 16:                 | STYLE 17:                 | STYLE 18:                 | STYLE 19:                      | STYLE 20:               |
|---------------------------|---------------------------|---------------------------|---------------------------|--------------------------------|-------------------------|
| PIN 1. GATE               | PIN 1. ANODE              | PIN 1. NO CONNECTION      | PIN 1. NO CONNECTION      | PIN 1. CATHODE                 | PIN 1. CATHODE          |
| <ol><li>CATHODE</li></ol> | <ol><li>CATHODE</li></ol> | <ol><li>ANODE</li></ol>   | <ol><li>CATHODE</li></ol> | <ol><li>ANODE</li></ol>        | <ol><li>ANODE</li></ol> |
| <ol><li>ANODE</li></ol>   | <ol><li>CATHODE</li></ol> | <ol><li>CATHODE</li></ol> | <ol><li>ANODE</li></ol>   | <ol><li>CATHODE-ANOD</li></ol> | E 3. GATE               |

| STYLE 21:                | STYLE 22:                | STYLE 23:    | STYLE 24:   | STYLE 25:    | STYLE 26:                       |
|--------------------------|--------------------------|--------------|-------------|--------------|---------------------------------|
| PIN 1. GATE              | PIN 1. RETURN            | PIN 1. ANODE | PIN 1. GATE | PIN 1. ANODE | PIN 1. CATHODE                  |
| <ol><li>SOURCE</li></ol> | <ol><li>OUTPUT</li></ol> | 2. ANODE     | 2. DRAIN    | 2. CATHODE   | 2. ANODE                        |
| 3 DRAIN                  | 3 INPLIT                 | 3 CATHODE    | 3. SOURCE   | 3. GATE      | <ol><li>NO CONNECTION</li></ol> |

| STYLE 27:<br>PIN 1. CATHODE<br>2. CATHODE<br>3. CATHODE | STYLE 28:<br>PIN 1. ANODE<br>2. ANODE<br>3. ANODE |  |
|---|---|--|
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